LM49270 Demonstration Board

National Semiconductor Application Note 1638 Vera Tsang May 2007



_M49270 Demonstration Board

General Description

The LM49270SQ demoboard is a fully assembled circuit board for use of evaluating the LM49270 Stereo Class D audio subsystem with OCL headphone amplifier, 3D enhancement, and headphone sense. The LM49270 operates from a 2.4V to 5.5V power supply. The filterless stereo class D amplifiers delivers 2.2W/channel into a 4Ω load with less than 10% THD+N with a 5V supply. The headphone amplifiers

feature National's Output Capacitor-less(OCL) architecture that eliminates the output coupling capacitors required by traditional headphone amplifiers. Additionally, the headphone amplifier can be configured as capacitively coupled loads.

The LM49270 features a 32 step volume control for the headphone and stereo output. The device mode select and volume are controlled through an I^2C compatible interface.

Bill of Materials

DESIGNATOR	QUANTITY	DESCRIPTION
		100µF ± 10% 10V
C1–C2	2	C Case Tantalum Capacitors
		AVX TPSC107K010R0075
		0.22µF ± 10% 16V X7R
C4	1	0603 Ceramic Capacitor
		Murata GRM188R71C223KA01D
2.2µF ± 10% 16V X7R		2.2µF ± 10% 16V X7R
C5	1	0805 Ceramic Capacitor
		Murata GRM21BR71A225KA01L
		1μF ± 10% 16V 1206
C6–C7	2	Ceramic Capacitors
		Murata GRM31MR71C105KA01L
10µF ± 10		$10\mu F \pm 10\% \ 16V$
C8	1	B Case Tantalum Capacitor
		AVX TPSB106K016R0500
		1μF ± 10% 16V 0805
C9–C12	4	Ceramic Capacitors
		Murata GRM21BR71C105KA01L
B1	1	$4.7 k\Omega \pm 0.1\%$
	•	Panasonic-ECG ERA-3AEB472V
R2 1		1kΩ ± 0.1%
112		Panasonic-ECG ERA-3AEB102V
R3	1	100k Ω Potentiometer
		Digikey ST4B104CT

AN-1638

Connectors

DESIGNATOR	LABEL	FUNCTION
JP1, JP2		These connectors are used to switch between CC or OCL mode. If JP1 and JP3 are open, then the LM49270 is in CC mode. If JP1 and JP3 are closed, then the LM49270 is in OCL mode.
JP3	VOC	JP3 is used to ground the VOC pin of the LM49270. In CC mode, JP3 should be closed, and the VOC amplifier is disabled.
JP4, JP5	LIN, RIN	These connectors are used for connecting the input to the LM49270. LIN (JP4) is for left input, and RIN (JP5) is for right input.
JP6	VDDLS	This connector is for the loudspeaker power supply connection. Apply an external power supply's positive voltage to the pin labeled VDDLS and the ground source to the pin labeled GND.
JP7, JP9	RIGHT SPEAKER, LEFT SPEAKER	These connectors are for the right speaker output (JP7) and left speaker output (JP9).
JP8	VDDI2C/ADR/ GND	There are three pins on this connector, VDDI2C, ADR, and GND. It is used to set the LM49270 address. To set the ADR bit to 1, close VDDI2C and ADR. To set the ADR bit to 0, close GND and ADR.
JP10		This connector should be closed when the user wants to use the VDDLS as the VDD source for the I2CVDD.
JP11	VDDI2C	This connector can be used to connect to a VDD source if the user wants to power the VDDI2C externally.
JP12	HPS	This connector is connected to the headphone sense pin of the part and the headphone jack. If JP12 is closed, then the headphone sense function works as designed with a headphone jack. If JP12 is open, then the user does not need a headphone jack to test the function of the HPS. To set to HP mode, set the right pin of JP12 to low. To set to speaker mode, set the right pin to high.
JP13, JP14	RHP, LHP	These connectors are for the right headphone output (JP13) and the left headphone output (JP14).
JP15	VDD	This connector provides the power supply connection. Apply an external power supply's positive voltage to the pin labeled VDD and the ground source to the pin labeled GND.
JP16		This connector is used to short the LHP to a pull down resistor. In CC mode, JP16 should be closed. In OCL mode, JP16 should be open.
JP17		This connector is used to short VDD and VDDLS together. If the user wanted to use only one power supply, then closing JP17 will allow the power supply to be connected to JP15 or JP6 only.

Quick Start - in CC Mode

1) Connect a shunt across the ADR and GND pins of jumper JP8. (I²C address bit = 0)

2) Connect a shunt across jumper JP3 (VOC = GND, Capacitor Coupled (CC) headphone mode).

3) Connect a shunt across jumper JP16 (for Capacitor Coupled (CC) headphone mode).

4) Connect a shunt across jumper JP12 to use the headphone sense function.

5) Connect an 8Ω speaker across jumper JP7 (Right Speaker output).

6) Connect an 8Ω speaker across jumper JP9 (Left Speaker output).

7) Connect a headphone to jack J1 (headphone jack).

8) Connect the 3.3V power supply to the VDD pin of jumper JP15 and the VDDLS pin of jumper JP6, and the power supply ground terminal to the GND pin of jumper JP15 and jumper JP6.

Connect the audio source to JP4 (left input) and JP5 (right input).

10) Connect I²C from PC to I²C Interface jumper.

11) Open LM49270 I2C control software.

12) Turn on power supply and audio source.

13) In the LM49270 I²C control panel, select "C-CUPL" in HEADPHONE OUTPUT COUPLING, and select CHIP POW-ER-ON mode "ON" to enable the device.

14) Adjust the volume controls to change the speaker and headphone volumes.

15) To enable the speakers, disconnect the headphone from jack J1.

Board Connections

POWER CONNECTIONS

Power Connections The LM49270 demoboard offers separate connections for the speaker amplifier and headphone amplifier power supplies. The separate power supplies allow the speakers to operate at a higher voltage for maximum headroom, while the headphones operate at a lower voltage, improving power dissipation. Connect the headphone amplifier power supply to the VDD pin and the power supply ground to the GND pin of jumper JP15. Connect the speaker amplifier power supply to the VDDLS pin and the power supply ground to the GND pin of JP6. As for the I²CV_{DD}, if powered from JP11, it allows the I²C portion of the LM49270 to interface with lower voltage digital controllers.

AUDIO INPUT CONNECTIONS

The left and right channel inputs of the LM49270 demoboard is configured for single-ended sources. Connect a left channel input source to the LIN pin and GND pin of JP4 and connect the a right channel input source to the RIN pin and GND pin of JP5.

AUDIO OUTPUT CONNECTIONS

Jumpers JP9 and JP7 are the connections for the left and right channel speakers output respectively. The jack, J1 is a 3.5mm stereo headphone jack with a headphone sense pin.

Jumper Selection

In CC mode, install a shunt across jumper JP3 and jumper JP16. In OCL mode, install a shunt across jumper JP1 and jumper JP2.

I²C Interface

The LM49270 is controlled through an I²C compatible serial interface. The LM49270 evaluation software provides an easy

to use graphical user interface (Figure 1). Each button corresponds to bits in an I²C command byte. See the LM49270 data sheet for detailed I²C information.

M49270 Audio Program v1.2			
National Semiconductor The Sight & Sound of Information	C ON OFF	CHIP POWER	ON © OFF
EADPHONE OUTPUT COUPLING	HEADPHONE 3D	C 1	BIT
DLUME CONTROLS		- 6.0 dB	DEFAUL

FIGURE 1. Evaluation Software Interface

CHIP POWER - ON

The Chip Power-On button enables or disables the entire device. The device will not output any audio if the Chip Power-On is set to "Off."

I²C ADDRESS BIT

The selection of this bit should correspond to the user's selection on jumper JP8. If the ADR pin is set to GND, then the I²C Address Bit should be set to '0'. If the ADR pin is set to VDDI2C, then the I²C Address Bit should be set to '1'.

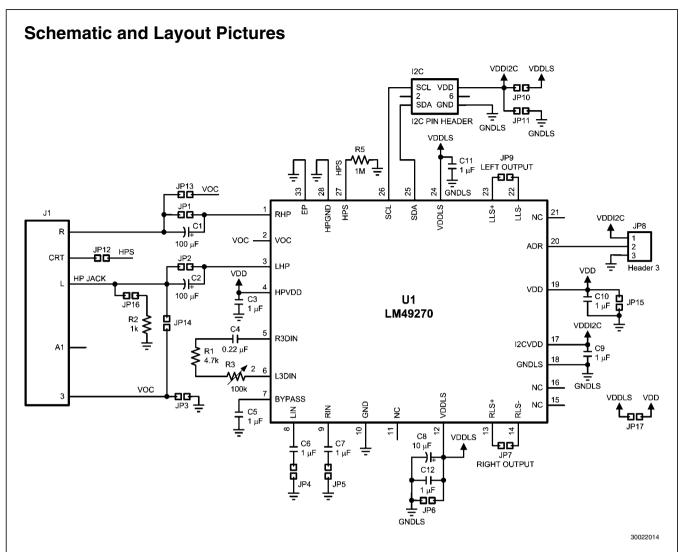
LOUDSPEAKER 3D, HEADPHONE 3D

The Loudspeaker 3D and Headphone 3D button enables 3D sound enhancement for loudspeaker and Headphone, re-

spectively. By setting it to "ON" turns on 3D and allows the user to increase or decrease the 3D effect on the demoboard by changing the value of the potentiometer in the external RC network of the LM49270.

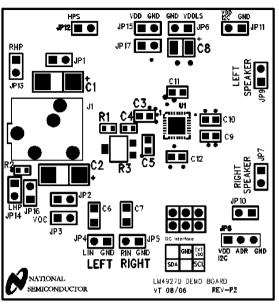
VOLUME CONTROL

The LM49270 headphone and speaker channels feature separate volume controls. The loudspeaker volume has a range of -49dB to 30dB and the headphone has a range of -59dB to 18dB, each with 32 steps.



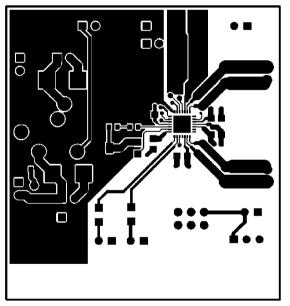


Demonstration Board PCB Layout



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FIGURE 3. Top Silkscreen Layer



30022009

FIGURE 4. Top Layer

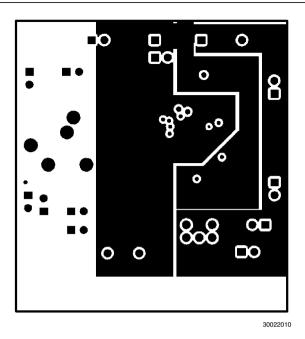


FIGURE 5. Mid Layer 1

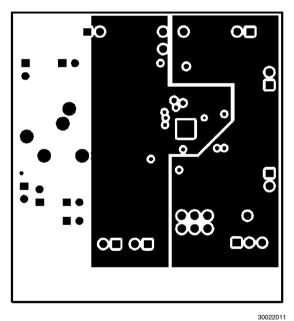


FIGURE 6. Mid Layer 2

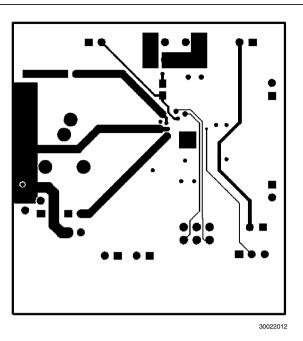
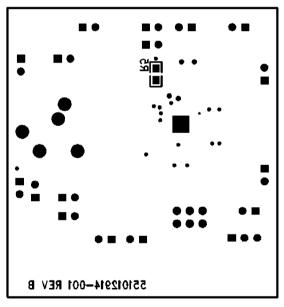


FIGURE 7. Bottom Layer



30022008

FIGURE 8. Bottom Silkscreen

Revision History						
	Rev	Date	Description			
	1.0	05/24/07	Initial release.			

Notes

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